

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5997436

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DONG HWAN KANG	02/27/2020
HYE JIN SUN	02/27/2020
RECEIVING PARTY DATA	
Name:	JEISYS MEDICAL INC.
Street Address:	96, GAMASAN-RO, GEUMCHEON-GU
Internal Address:	#307, DAERUNG TECHNO TOWER 8-CHA
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	08501
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29726679
CORRESPONDENCE DATA	
Fax Number:	(866)613-4037
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7039944208
Email:	mail@revolutioniplaw.com
Correspondent Name:	REVOLUTION IP, PLLC
Address Line 1:	2000 DUKE ST.
Address Line 2:	SUITE 300
Address Line 4:	ALEXANDRIA, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	3170-068
NAME OF SUBMITTER:	SANGWON KIM
SIGNATURE:	/sangwon kim/
DATE SIGNED:	03/05/2020
Total Attachments: 4	
source=3-3170-068DeclarationandAssignment#page1.tif	
source=3-3170-068DeclarationandAssignment#page2.tif	
source=3-3170-068DeclarationandAssignment#page3.tif	

ASSIGNMENT SERVING AS DECLARATION PER 37 C.F.R. § 1.63(e)

Title of
Invention:

NEEDLE TIP

As a below named inventor and Assignor, I declare that:

This assignment and declaration are directed to:

- The attached application, or
 United States application or PCT international application number
_____ filed on _____.

The above-identified Application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the Application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Whereas, Assignor has invented certain new and useful processes, machines, articles of manufacture, compositions of matter, and/or improvements thereof ("Invention") disclosed in the Application,

Whereas, Assignor desires to convey all rights, titles, and interests in and to the same to:

JEISYS MEDICAL INC.
#307, Daerung Techno Tower 8-cha, 96, Gamasan-ro, Geumcheon-gu,
Seoul 08501, Republic of Korea

JEISYS MEDICAL INC. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority

based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

IN WITNESS WHEREOF, Inventor and Assignor has hereunto set hand and seal.

Inventor's and Assignor's Name: **KANG, Dong Hwan**

Address: 106-1603,
717, Gyeongwon-daero, Michuhol-gu,
Incheon 22229, Republic of Korea

Inventor's and Assignor's Signature:



Date:

Feb. 27, 2020

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Whereas, Assignor desires to convey all rights, titles, and interests in and to the same to:

JEISYS MEDICAL INC.
#307, Daerung Techno Tower 8-cha, 96, Gamasan-ro, Geumcheon-gu,
Seoul 08501, Republic of Korea

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Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority

based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

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Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

IN WITNESS WHEREOF, Inventor and Assignor has hereunto set hand and seal.

Inventor's and Assignor's Name:

SUN, Hye Jin

Address:

#202,
32, Gyeongin-ro 251beon-gil, Michuhol-gu,
Incheon 22120, Republic of Korea

Inventor's and Assignor's Signature:



Date:

Feb. 27, 2020